捷多邦,专业PCB打样**SN**54**AH©540**世**SN**74AHC540 OCTAL BUFFERS/DRIVERS WITH 3-STATE OUTPUTS

SCLS260H - DECEMBER 1995 - REVISED JANUARY 2000

- EPIC™ (Enhanced-Performance Implanted CMOS) Process
- Operating Range 2-V to 5.5-V V_{CC}
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- Package Options Include Plastic Small-Outline (DW), Shrink Small-Outline (DB), Thin Very Small-Outline (DGV), Thin Shrink Small-Outline (PW), and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) DIPs

description

The 'AHC540 octal buffers/drivers are ideal for driving bus lines or buffer memory address registers. These devices feature inputs and outputs on opposite sides of the package to facilitate printed circuit board layout.

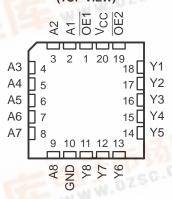
The 3-state control gate is a two-input AND gate with active-low inputs so that if either output-enable (OE1 or OE2) input is high, all corresponding outputs are in the high-impedance state. The outputs provide inverted data when they are not in the high-impedance state.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

SN54AHC540 . . . J OR W PACKAGE SN74AHC540 . . . DB, DGV, DW, N, OR PW PACKAGE (TOP VIEW)



SN54AHC540 . . . FK PACKAGE (TOP VIEW)



The SN54AHC540 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74AHC540 is characterized for operation from –40°C to 85°C.

FUNCTION TABLE (each buffer/driver)

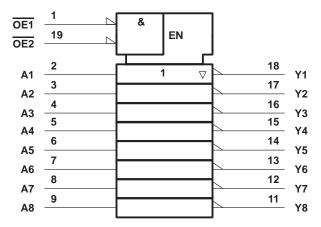
	INPUTS	OUTPUT	
OE1	OE2	Α	Y
L	L	L	Н
L	L	Н	L
Н	X	X	Z
X	ЛН	X	Z

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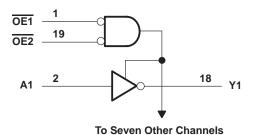


logic symbol†



[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

logic diagram (positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage range, V _{CC}		0.5 V to 7 V
Input voltage range, V _I (see Note 1)		
Output voltage range, VO (see Note 1)		0.5 V to V_{CC} + 0.5 V
Input clamp current, I_{IK} ($V_I < 0$)		
Output clamp current, IOK (VO < 0 or VO > VCO	c)	±20 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})		±25 mA
Continuous current through V _{CC} or GND		±75 mA
Package thermal impedance, θ _{JA} (see Note 2)): DB package	70°C/W
	DGV package	92°C/W
	DW package	58°C/W
	N package	69°C/W
	PW package	83°C/W
Storage temperature range, T _{stg}		–65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
 - 2. The package thermal impedance is calculated in accordance with JESD 51.



recommended operating conditions (see Note 3)

			SN54A	HC540	SN74A	HC540	UNIT
			MIN	MAX	MIN	MAX	UNII
Vcc	Supply voltage		2	5.5	2	5.5	V
		V _{CC} = 2 V	1.5		1.5		
V_{IH}	High-level input voltage	V _{CC} = 3 V	2.1		2.1		V
		$V_{CC} = 5.5 V$	3.85		3.85		
		V _{CC} = 2 V		0.5		0.5	
\vee_{IL}	Low-level input voltage	V _{CC} = 3 V		0.9		0.9	V
		$V_{CC} = 5.5 \text{ V}$		1.65		1.65	
٧ _I	Input voltage		0	5.5	0	5.5	V
Vo	Output voltage		0	VCC	0	VCC	V
		$V_{CC} = 2 V$		-50		-50	μΑ
IOH	High-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		-4		-4	mA
		$V_{CC} = 5 V \pm 0.5 V$		-8		-8	
		$V_{CC} = 2 V$		50		50	μΑ
loL	Low-level output current	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		4		4	mA
		$V_{CC} = 5 V \pm 0.5 V$		8		8	
Δt/Δν	langet transition rise or fall rate	$V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$		100		100	0/
ΔυΔν	Input transition rise or fall rate	$V_{CC} = 5 V \pm 0.5 V$		20		20	ns/V
TA	Operating free-air temperature		-55	125	-40	85	°C

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, Implications of Slow or Floating CMOS Inputs, literature number SCBA004.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CONDITIONS	Vac	T _A = 25°C			SN54AHC540		SN74AHC540		
PARAMETER	TEST CONDITIONS	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
		2 V	1.9	2		1.9		1.9		
Vон	I _{OH} = -50 μA	3 V	2.9	3		2.9		2.9		
		4.5 V	4.4	4.5		4.4		4.4		V
	I _{OH} = -4 mA	3 V	2.58			2.48		2.48		
	I _{OH} = -8 mA	4.5 V	3.94			3.8		3.8		
		2 V			0.1		0.1		0.1	
	I _{OL} = 50 μA	3 V			0.1		0.1		0.1	
VOL		4.5 V			0.1		0.1		0.1	V
	I _{OL} = 4 mA	3 V			0.36		0.5		0.44	
	I _{OL} = 8 mA	4.5 V			0.36		0.5		0.44	
ΙΙ	V _I = V _{CC} or GND	0 V to 5.5 V			±0.1		±1*		±1	μΑ
loz†	$V_O = V_{CC}$ or GND, $V_I (\overline{OE}) = V_{IL}$ or V_{IH}	5.5 V			±0.25		±2.5		±2.5	μΑ
Icc	$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			4		40		40	μΑ
C _i	$V_I = V_{CC}$ or GND	5 V		2	10				10	pF
Co	$V_O = V_{CC}$ or GND	5 V		4						pF

 $^{^*}$ On products compliant to MIL-PRF-38535, this parameter is not production tested at $V_{CC} = 0 \text{ V}$.

 $[\]ensuremath{^{\dagger}}$ For I/O pins, the parameter IOZ includes the input leakage current.



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switching characteristics over recommended operating free-air temperature range, V_{CC} = 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	LOAD	T,	ղ = 25°C	;	SN54A	HC540	SN74AI	HC540	UNIT
PARAMETER	(INPUT)	(OUTPUT)	CAPACITANCE	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
t _{PLH}	А	Y	C _I = 15 pF		4.8*	7*	1*	8.5*	1	8.5	ns
t _{PHL}	A	ī	CL = 15 pr		4.8*	7*	1*	8.5*	1	8.5	115
^t PZH	ŌĒ	Y	C _I = 15 pF		6.8*	10.5*	1*	12.5*	1	12.5	ns
tPZL	OE	'	CL = 13 pr		6.8*	10.5*	1*	12.5*	1	12.5	115
^t PHZ	ŌĒ	Y	C _I = 15 pF		6.8*	10.5*	1*	12.5*	1	12.5	ns
t _{PLZ}	OE	'	CL = 13 pr		6.8*	10.5*	1*	12.5*	1	12.5	115
^t PLH	А	Y	C _I = 50 pF		7.3	10.5	1	12	1	12	ns
^t PHL	^	'	CL = 30 pr		7.3	10.5	1	12	1	12	115
^t PZH	ŌĒ	Y	C _I = 50 pF		8	14	1	16	1	16	ns
t _{PZL}	OE	'	CL = 30 pr		8	14	1	16	1	16	115
^t PHZ	ŌĒ	Y	C _I = 50 pF		8	15.4	1	17.5	1	17.5	ns
tPLZ	OE	ſ	CL = 50 pr		8	15.4	1	17.5	1	17.5	115
tsk(o)			C _L = 50 pF			1.5**				1.5	ns

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

DADAMETER	FROM	то	LOAD	T,	Δ = 25°C	;	SN54AI	HC540	SN74AI	HC540	LINIT
PARAMETER	(INPUT) (OUTPUT) CAPACITANCE		MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT	
^t PLH	А	Y	C _I = 15 pF		3.7*	5*	1*	6*	1	6	ns
^t PHL		'	CL = 13 pr		3.7*	5*	1*	6*	1	6	115
^t PZH	ŌĒ	Y	C _L = 15 pF		4.7*	7.2*	1*	8.5*	1	8.5	ns
t _{PZL}	OE	'	CL = 13 pr		4.7*	7.2*	1*	8.5*	1	8.5	115
^t PHZ	ŌĒ	Y	C _L = 15 pF		4.5*	6.8*	1*	8*	1	8	ns
t _{PLZ}	OE OE	'	CL = 13 pr		4.5*	6.8*	1*	8*	1	8	115
^t PLH	А	Y	C _I = 50 pF		5.2	7	1	8	1	8	ns
^t PHL	^	'	CL = 30 pr		5.2	7	1	8	1	8	115
^t PZH	ŌĒ	Y	C _I = 50 pF		6.2	9.2	1	10.5	1	10.5	ns
^t PZL	OE	'	С[= 30 рі		6.2	9.2	1	10.5	1	10.5	113
^t PHZ	ŌĒ	Y	C _L = 50 pF		6	8.8	1	10	1	10	ns
t _{PLZ}	OE	1	OL = 30 pr		6	8.8	1	10	1	10	115
tsk(o)			C _L = 50 pF			1**				1	ns

^{*} On products compliant to MIL-PRF-38535, this parameter is not production tested.



^{**} On products compliant to MIL-PRF-38535, this parameter does not apply.

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noise characteristics, V_{CC} = 5 V, C_L = 50 pF, T_A = 25°C (see Note 4)

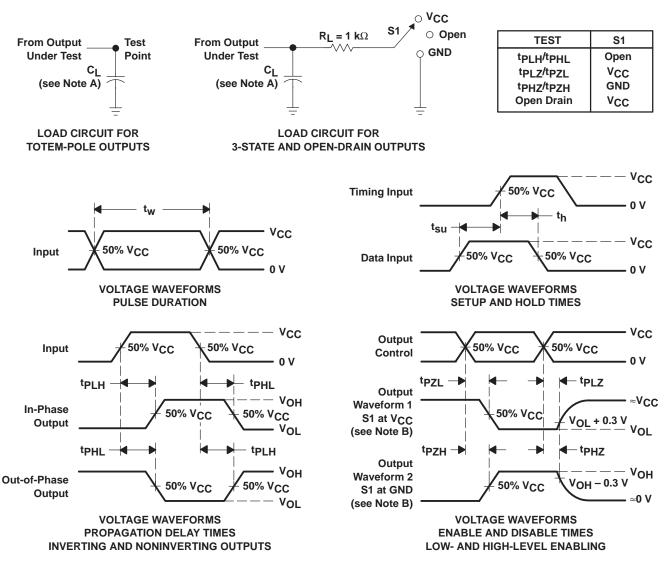
	PARAMETER					
	PARAMETER	MIN	MAX	UNIT		
V _{OL(P)}	Quiet output, maximum dynamic V _{OL}		0.8	V		
V _{OL(V)}	Quiet output, minimum dynamic V _{OL}		-0.8	V		
V _{OH(V)}	Quiet output, minimum dynamic V _{OH}	4.7		V		
VIH(D)	High-level dynamic input voltage	3.5		V		
V _{IL(D)}	Low-level dynamic input voltage		1.5	V		

NOTE 4: Characteristics are for surface-mount packages only.

operating characteristics, V_{CC} = 5 V, T_A = 25°C

	PARAMETER	TEST CONDITIONS	TYP	UNIT
C _{pd}	Power dissipation capacitance	No load, f = 1 MHz	12	pF

PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_I includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \,\Omega$, $t_f \leq 3$ ns. $t_f \leq 3$ ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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